

Title (en)  
LIGHT EMITTING DEVICE PACKAGE

Title (de)  
GEHÄUSE FÜR LICHEMITTIERENDE VORRICHTUNG

Title (fr)  
BOÎTIER DE DISPOSITIF ÉLECTROLUMINESCENT

Publication  
**EP 2820685 A4 20150930 (EN)**

Application  
**EP 13754120 A 20130226**

Priority  
• KR 20120019852 A 20120227  
• KR 2013001549 W 20130226

Abstract (en)  
[origin: WO2013129820A1] A light emitting device package includes: a package body having a first cavity; an electrode layer comprising a first electrode and a second electrode which are electrically isolated from each other; a light emitting device electrically connected to the electrode layer on the package body; a protective device disposed in a second cavity formed at the package body and electrically connected to the electrode layer; a reflective layer on the protective device; and a molding part on the light emitting device, wherein at least one of the first electrode and the second electrode is disposed on the package body.

IPC 8 full level  
**H01L 25/16** (2006.01); **H01L 33/48** (2010.01); **H01L 33/60** (2010.01); **H01L 33/62** (2010.01)

CPC (source: CN EP KR US)  
**H01L 25/167** (2013.01 - CN EP US); **H01L 33/48** (2013.01 - KR US); **H01L 33/52** (2013.01 - KR); **H01L 33/60** (2013.01 - CN EP KR US); **H01L 33/62** (2013.01 - CN EP US); **H01L 2224/48091** (2013.01 - CN EP US); **H01L 2224/49109** (2013.01 - CN EP US); **H01L 2924/1301** (2013.01 - CN EP US)

Citation (search report)  
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Designated contracting state (EPC)  
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**KR 2013001549 W 20130226**; CN 201380022332 A 20130226; EP 13754120 A 20130226; JP 2014559825 A 20130226; KR 20120019852 A 20120227; TW 102106945 A 20130227; US 201314381057 A 20130226